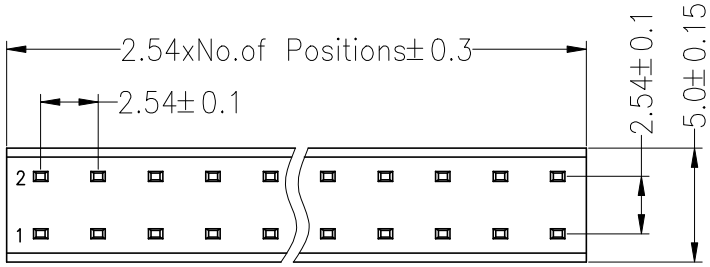
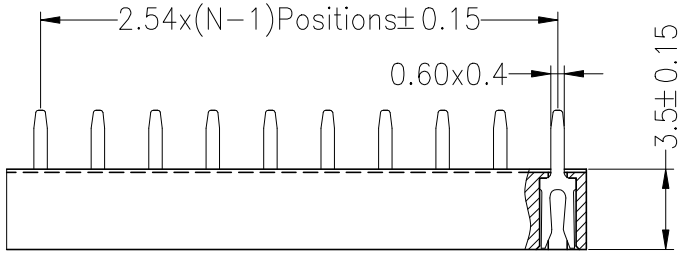
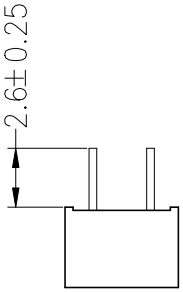
HSF RoHS

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



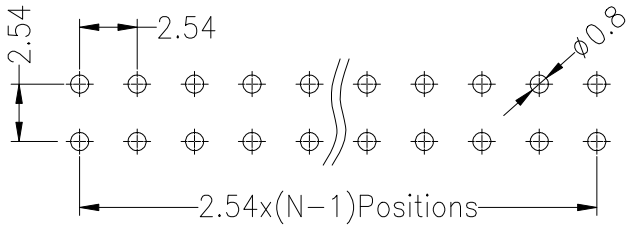




Ordering Information

2235 02 XX X N XX S Y X 0X

- XX: No.of Pins Per Row 2−40
- X: Insulator Material Option
  - A=BK−PBT
  - C=BK−PA6T
  - F=BK−LCP
- XX: Contact Plating
  - G1:Gold Flash
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - G6:10U" Gold
  - G7:15U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X: Packing
  - A=Tray
  - T=Tube
  - R=Reel



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2016.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	16.03.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	223502XXXNXXSYX0X
TITLE:	2.54PF H3.50mm 2xNpin 180° Y端